

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4099127

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YAN LIU	09/12/2016
JUN CHEN	09/12/2016
RECEIVING PARTY DATA	
Name:	HONG KONG APPLIED SCIENCE AND TECHNOLOGY RESEARCH INSTITUTE COMPANY LIMITED
Street Address:	5TH FLOOR, PHOTONICS CENTRE, 2 SCIENCE PARK EAST AVENUE,
Internal Address:	HONG KONG SCIENCE PARK, SHATIN, NEW TERRITORIES
City:	HONG KONG
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15270681
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2022169505
Email:	docketing@steinip.com
Correspondent Name:	MICHAEL D. STEIN
Address Line 1:	1400 EYE STREET, NW
Address Line 4:	WASHINGTON, D.C. 20005
ATTORNEY DOCKET NUMBER:	0563.1002
NAME OF SUBMITTER:	MICHAEL D. STEIN
SIGNATURE:	/Michael D. Stein/
DATE SIGNED:	10/17/2016
Total Attachments: 1	
source=DeclarationAssignment_101716#page1.tif	

COMBINED DECLARATION/ASSIGNMENT FOR UTILITY/DESIGN PATENT APPLICATION**OATH OR DECLARATION**

As a below named inventor, I hereby declare that:

This combined declaration and assignment is directed to the application entitled:

ANTENNA SYSTEM FOR WIRELESS CHARGING

the specification of which is attached hereto, or was filed on _____ as United States Application Number (or PCT International Application Number) _____ and was amended on _____ (if applicable).

Any registered attorney of STEIN IP, LLC, 1400 Eye St., N.W., Suite 300, Washington, D.C. 20005 (202-216-9505), USPTO Customer Number 49,455, is hereby authorized to insert the specified data into the above paragraph, when known.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

IN CONSIDERATION of good and valuable consideration paid to me, an undersigned inventor, by

Hong Kong Applied Science and Technology Research Institute Company Limited
5th Floor, Photonics Centre, 2 Science Park East Avenue,
Hong Kong Science Park,
Shatin, New Territories
Hong Kong

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, I hereby sell, assign and transfer to ASSIGNEE the entire and exclusive right, title and interest to the above-identified application and the claimed invention therein, and any continuation, division, renewal, substitute, reissue or reexamination application based thereon (collectively, hereinafter, "said application(s)"), and all Letters Patent of the United States granted on said application(s), for the full term or terms for which the said Letters Patent may be granted and including any extensions thereof (collectively, hereinafter, "said Letters Patent").

I agree, when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent, in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

I covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

IN WITNESS WHEREOF, I have affixed my signature on the date beneath.

Full name of sole/first inventor Yan LIU

Inventor's Signature  Executed 12 SEP 2016

Inventor's Mailing Address 10F/C Eightland Gardens, BLK3, No.2 On Chee Road, Tai Po, N.T., Hong Kong

Inventor's Residence 10F/C Eightland Gardens, BLK3, No.2 On Chee Road, Tai Po, N.T., Hong Kong

Full name of second inventor Jun CHEN

Inventor's Signature  Executed 12 SEP 2016

Inventor's Mailing Address Flat 1620, Horizon Suite Hotel, 29 On Chun Street, Ma On Shan, Shatin, Hong Kong

Inventor's Residence Flat 1620, Horizon Suite Hotel, 29 On Chun Street, Ma On Shan, Shatin, Hong Kong